

CYANIDE-BASED SILVER ALLOY ELECTROPLATING SOLUTION

ABSTRACT

The present invention provides a cyanide-based silver alloy electroplating solution characterized by containing 10 to 100 g/L of silver cyanide complex in terms of silver, 5 to 300 g/L of electroconductive salt, 0.1 to 10 g/L of germanium compound in terms of germanium, and 1 to 100 g/L of a coordinating polymer additive.

[No Figure]